



POE-D10-00-E-11

SAFETY STANDARDS REGULATED, REINFORCED INSULATION TYPE, AH SERIES

Ver: 11

Page: 1 / 18

PRODUCT SPECIFICATION

PRODUCT: CERAMIC DISC CAPACITOR SAFETY RECOGNIZED

TYPE: AH SERIES

CUSTOMER:

DOC. NO.: POE-D10-00-E-11

Ver.: 11

APPROVED BY CUSTOMER

VENDOR:

☐ HITANO ENTERPRISE CORP.

7F-7, NO. 3, WU CHUAN 1ST ROAD, NEW TAIPEI INDUSTRIAL PARK, NEW TAIPEI CITY, TAIWAN, R.O.C.

TEL: +886 2 2299 1331 (REP.) FAX: +886 2 2298 2466 HITANO ENTERPRISE CORP. ®

MAKER:

☐ PAN OVERSEAS (GUANGZHOU) ELECTRONIC CO.,LTD.

NO.277,HONG MING ROAD,EASTERN SECTION, GUANG ZHOU ECONOMIC AND TECHNOLOGY DEVELOPMENT ZONE,CHINA



POE

HITANO ENTERPRISE CORP. ®	POE		POE-D10-00-E-11
SAFETY STANDARDS REGULATED, REINFORCED INSULATION TYPE, AH SERIES		Ver: 11	Page: 2 / 18

Record of change

Date	Version	Description	page
2008.6.3	1	$1.D22-00-E-01(before) \rightarrow POE-D10-00-E-01(1^{st} edition)$	
2008.8.22	2	1 Complete lead code	21
		2. Add last SAP code "H" for halogen and Pb free, epoxy resin	3
2008.12.12	3	1. Complete the 13 th to 17 th codes of SAP P/N.	4-5
		2. Page layout adjustment.	
2009.7.8	4	1. Complete Marking statement.	10
		2. Revised standard NO. of SEV, SEMKO, FIMKO, NEMKO,	12
		DEMKO and KEMA.	
		Revised recognized NO. of FIMKO, NEMKO, DEMKO and KEMA.	
2009.9.14	5	1. H0: 18.0+2.0/-1.5 revised to 18.0+2.0/-0	9
		2. "Protrusion length": "+0.5to-1.0" revised to "2.0max (Or the end of lead wire may be inside the tape.)"	9
		3. Add "250V~" under the "UL" mark according to the product's marking.	10
2009.12.24	6	1. Marking	10
		2. Correct X1 of recognized No by KTL.	11
		3. Revised the Figure of impulse voltage test(Item 7.3.14) according to the standard IEC 60384-14 ed.3	14
		4. Add "1AH" code for Y1:400V marking type.	4
2011.1.11	7	1. Review SAP P/N about diameter code: YU*AH561K100*→YU*AH561K080*	6
		2. Delete "AT" taping type.	4,5,8,9
		3. Add test item "Temperature Cycle".	14
		4. Add item 10 "Drawing of internal structure and material list"	19
2011.5.12	8	1. Review the safety standards approval and recognized no.	10
		2. Delete "old P/N"	5~6
		3. Add the special marking for P/N:YP*AH102K100	9
2012.1.30	9	1. Review the approval rated voltage of UL and the marking.	8~9
2012/4/6	10	In order to improve the traceability of the product, change the date code on capacitor body, new date code can trace back to	8
		production "Lot No."	5 6 7
		 Review the Lead diameter φ from 0.60 +0.1/-0.05mm to 0.5+/-0.1mm Add"3.1Norminal parts&3.2 special for surge parts" for "3. Part 	5,6,7
		2. Add"3.1Norminal parts&3.2 special for surge parts" for "3. Part numbering/T.C/Capacitance/ Tolerance/Diameter"	6
		3. In order the customer to know the round time of manufacture,	8
		change the date code on capacitor body, new date code can know	U
2013/5/13	11	the month of manufacture.	
		4. Delete "No marked with "_" stand for Pb free".	8
		5. Delete "When the TCC is $\overline{Y}5V(YV)$, there is a "F" between the	8
		"AH" and capacitance code."	
		6. Review the Solderability time from 2 ± 0.5 s to 5 ± 0.5 s	11



Table of Contents

No.	Item	Page
1	Part number for SAP system	4/18
2	Mechanical	5/18
3	Part numbering/T.C/Capacitance/ Tolerance/Diameter	6/18
4	Taping Format	7/18
5	Marking	8/18
6	Scope	9/18
7	Specification and test method	10/18~13/18
8	Packing specification	14/18
9	Notices	15/18~1/18
10	Drawing of Internal Structure and material list	18/18

1. Part numbering:

(Ex.) YU OAH 472 M 13 O L 20 C O B (1) (2) (3) (4) (5) (6) (7) (8) (9) (10) (11)

(1)Temperature characteristic (identified code)

CODE	CH(NP0)	SL	YP (Y5P)	YV(Y5V)	YU (Y5U)
Cap. Change	0±60PPM/°C	-1000~+350PPM/°C (+20°C~+85°C)	±10%	-80% ~ +30%	-55% to +20%

Remark(brevity code): $Y5P \rightarrow B \cdot Y5V \rightarrow F \cdot Y5U \rightarrow E$

(2)TYPE (identified by 3-figure code) : $0AH = AH \text{ Type}(X1:400V \sim /Y1:250V \sim)$,

1AH=AH Type(X1:400V~/Y1:400V~)

- (3)Capacitance (identified by 3-figure code):EX.221=220pF
- (4) Capacitance tolerance (identified by code): C:±0.25pF,D:±0.5pF,J:±5%,K:±10%,M:±20%
- (5)Nominal body diameter dimension (identified by 3-figure code)
- (6)Internal code: 0--Normal, other code--Special control
- (7)Lead Style: Refer to "2. Mechanical".
- (8)Packing mode and lead length (identified by 2-figure code)

Taping Code	Description
AM	Ammo box and product pitch: 25.4 mm

Bulk Code	Description					
3E	Lead length : 3.5mm					
04	Lead length : 4.0mm					
4E	Lead length : 4.5mm					
20	Lead length : 20mm					

(9)Length tolerance

Code	Description					
A	±0.5 mm					
	(only for kink lead type)					
В	±1.0 mm					
С	Min.					
D	Taping special purpose					

(10)Pitch

Code	Description
0	10±1 mm
A	10±0.5 mm

(11)Epoxy Resin Code

Code	Description			
В	Pb free, Epoxy Resin			
Н	Halogen and Pb free, epoxy resin.			



2. Mechanical:

Encapsulation: Epoxy resin, flammability UL94 V-0

Available lead code (unit: mm):

Lead type	SAP P/N (13-17)digits	Pitch (F)	Lead Length (L)	Packing	Lead Configuration
Lead style : L Type L Straight long lead	L20C0	10 ± 1.0	20 min.	Bulk	Dmax. Tmax.
Lead style: B Type B Straight long lead	BAMD0	10 ± 1.0	Refer to "4. Taping format"	Tap. Ammo	Dmax. Tmax.
	L03B0	10 ± 1.0	3.0 ± 1.0		_DmaxTmax_
Lead style: L Type L Straight short	L4EB0	10 ± 1.0	4.5 ± 1.0	Bulk	Q: L:
lead	L05B0	10 ± 1.0	5.0 ± 1.0		Ø8
Lead style: D	D3EA0	10 ± 1.0	3.5 ± 0.5	D 11	Dmax. Tmax.
Type D	D04A0	10 ± 1.0	4.0 ± 0.5	Bulk	A 1
Vertical kink lead	DAMD0	10 ± 1.0	Refer to "4. Taping format"	Tap. Ammo	Ød L
Lead style : X Type X Outside kink lead	X3EA0	10 ± 1.0	3.5 ± 0.5		Dmax. Tmax.
	X04A0	10 ± 1.0	4.0 ± 0.5	Bulk	Mě Děl
	X05B0	10 ± 1.0	5.0 ± 1.0		5.0max
	XAMD0	10 ± 1.0	Refer to "4. Taping format"	Tap. Ammo	Ød L

^{*} Lead diameter Φd: 0.50 +0.1/-0.1mm

^{*}e (Coating extension on leads): 3.0mmMax for straight lead lead style, not exceed the kink for kink lead.

HITANO ENTERPRISE CORP. O	POElectronic POE		POE-D10-00-E-11
SAFETY STANDARDS REGULATED, REINFORCED INSULATION TYPE, AH SERIES		Ver: 11	Page: 6 / 18

3. Part numbering/T.C/Capacitance/ Tolerance/Diameter:

3.1 Nominal parts:

SAP P/N	T.C.	Capacitance(pF)	Tolerance		Dimens	sion (unit:n	nm)
SAF F/N	1.C.	Capacitance(pr)	Tolerance	D(max.)	T(max.)	F	Фd
CH*AH***C060*		2, 3,4, 5(pF)	±0.25pF	7.0			
CH*AH***D060*	СН	6,7,8,9,10(pF)	±0.5pF	7.0			
CH*AH120J060*	(NP0)	12		7.0			
CH*AH***J070*		15,18,20,22,24,27(pF)		8.0			
SL*AH***J060*		15,18,20,22,24,27,30, 33, 36, 39(pF)	±5%	7.0			
SL*AH***J070*	SL*	47,50,51, 56,62(pF)		8.0			
SL*AH***J080*		68,75,82(pF)		9.0			
SL*AH101J090*		100pF		10.0	5.0	10±1	0.5 ± 0.1
YP*AH101K060*		100 pF		7.0			
YP*AH151K060*		150 pF		7.0			
YP*AH221K060*		220 pF]	7.0			
YP*AH331K060*	Y5P	330 pF	10%	7.0			
YP*AH471K070*	131	470 pF 10% 8.0					
YP*AH561K080*		560 pF		9.0			
YP*AH681K080*		680 pF		9.0			
YP*AH102K100*		1000 pF		11.0			
YU*AH102M070*		1000 pF		8.0			
YU*AH152M080*		1500 pF		9.0			
YU*AH222M090*	Y5U	2200 pF		10.0	5.0		
YU*AH332M110*	130	3300 pF		12.0	5.0		
YU*AH392M120*		3900 pF		14.0			
YU*AH472M130*	Y5V	4700 pF	20%	14.0		10±1	0.5 ± 0.1
YV*AH102M060*		1000pF		7.0			
YV*AH152M070*		1500pF		8.0			
YV*AH222M080*		2200pF		9.0	5.5		
YV*AH332M100*		3300pF		11.0			
YV*AH472M110*		4700pF		12.0			

[•] The minimum thickness of coating (reinforced insulation) is 0.4mm.

3.2 Special for surge parts:

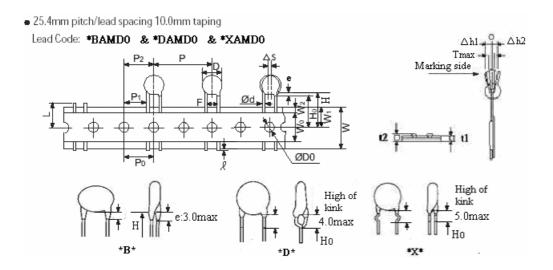
Don't Namehou	Town Chan	Com (mE)	Tal	Dimension (mm)			1)
Part Number	Temp. Char.	Cap.(pF)	Tol.	D Max.	T Max.	F±1	Wire Dia. (φd)
YP *AH101K06S		100		7.0			
YP *AH151K06S		150		7.0			
YP *AH221K06S		220		7.0			
YP *AH331K07S	Y5P	330	10%	8.0	6.0	10.0	0.5 ± 0.1
YP *AH471K08S		470		9.0			
YP *AH681K09S		680		10.0			
YP *AH102K11S		1000		12.0			
YU*AH102M07S		1000		8.0			
YU*AH152M08S		1500		9.0			
YU*AH222M09S	Y5U	2200	20%	10.0	6.0	10.0	0.5±0.1
YU*AH332M11S	130	3300	2070	12.0	0.0	10.0	0.5±0.1
YU*AH392M12S		3900		14.0			
YU*AH472M13S		4700		14.0			

[•] The special parts only improve surge withstanding, but can't independently be used in protecting application against surges.)

HITANO ENTERPRISE CORP.	POE POE		POE-D10-00-E-11
SAFETY STANDARDS REGULATED, REINFORCED INSULATION TYPE, AH SERIES		Ver: 11	Page: 7 / 18

4. Taping Format:

Part number: aa0AHaaaaaaaAMDaB



POE Part Number		*BAMD0 / *DAMD0 / *XAMD0		
Item	Symbol	Dimensions(mm)		
Pitch of component	P	25.4 ± 2		
Pitch of sprocket	P0	12.7 ± 0.3		
Lead spacing	F	10.0 ± 1.0		
Length from hole center to component center	P2	12.7 ± 1.5		
Length from hole center to lead	P1	7.7 ± 1.5		
Body diameter	D	See the "3. Part numbering/T.C/Capacitance/ Tolerance/Diameter"		
Deviation along tape, life or right	\triangle S	0 ± 2.0		
Carrier tape width	W	18.0 +1/ -0.5		
Position of sprocket hole	W1	9.0 ± 0.5		
Lead distance between the kink and center of sprocket hole	Н0	18.0 +2.0/-0 (For: *DAMD0 & *XAMD0)		
Lead distance between the bottom of body and the center of sprocket hole	Н	20.0+1.5/-1.0 (For: *BAMD0)		
Protrusion length	l	2.0max (Or the end of lead wire may be inside the tape.)		
Diameter of sprocket hole	D0	4.0 ± 0.2		
Lead diameter	φd	0.5 ±0.1		
Total tape thickness	t1	0.6 ± 0.3		
Total thickness, tape and lead wire	t2	1.5 max.		
Deviation across tape	\triangle h1	2.0 max.		
Deviation across tape	\triangle h2	2.0 max		
Portion to cut in case of defect	L	11.0 max.		
Hole-down tape width	W0	8.0 min		
Hole-down tape distortion	W2	1.5 ± 1.5		
Coating extension on leads	e	3.0 max for straight lead style; Not exceed the kink leads for kink lead.		
Body thickness	T	See the "3. Part numbering/T.C/Capacitance/ Tolerance/Diameter"		



5. Marking:

Marking:							
1.Type Designation	AH						
2.Nominal Capacitance	3-digit-system	3-digit-system					
3.Capacitance Tolerance	C:±0.25pF,D:±0.5pF,J:±5%,K:±10%,M:±20%						
4.Company Name Code(Trade mark)	K						
5.Manufactured Date	Abbreviation of Last digits of yet 3:2013 4:2014 5:2015	Epoxy resin code: "-": Halogen and I	Mon 1:Ja 1:9 9:Se 0:00 N:N	digits of Lot no. th of manufacture inuary ptember ctober ovember ecember			
6.Approved Monogram:							
(1) VDE approval mark	10 /ove	EC 60384-14 3rd (2005 Class Code : X1 : 400V	,	250V~ or400V~			
(2) UL approval mark	71	6) DEMKO approval m	ark	D			
(3) CSA approval mark		7) FIMKO approval ma	ırk	(FI)			
(4) SEMKO approval mark	(S)	8) SEV approval mark		(\$			
(5) NEMKO approval mark	N (9) CQC approval mark		@			
Normal	marking		YP*AH102K***** (Special marking)				
OAH: OAH:	One side: OAH: IAH: UK		ОАН	AH102K AH102K 250V~ Y1:250V~ 3C61234			
1AH: (1230) 3C61234 * Marking by the stamp or laser			1АН	AH102K AH102K (10 FL) (12 Y1:400V~ (12 Y1:400V~ (13 C) (13 C) (13 C) (14 C) (15 C) (16 C) (17			

^{*} Marking by the stamp or laser.

* The marking can be printed on either one side or two side of coating body.

* "C": Marked with code "_" stand for Halogen and Pb free epoxy resin.



6. Scope:

THIS SPECIFICATION APPLIES TO CERAMIC INSULATED CAPACITORS DISK TYPE USED IN ELECTRONIC EQUIPMENT.

6.1Applicable safety standard

This specification applies to the VDE, SEV, SEMKO, FIMKO, NEMKO, DEMKO, KEMA, KTL, UL, CSA approved ceramic capacitors disc type for antenna coupling, line-by-pass and across-the-line. X1, Y1 capacitor based on IEC384-14 3rd edition. "UL, CSA recognized capacitor for across-the-line, line-by-pass" and antenna-isolation.

6.2 Safety standards approval and recognized no.

Safety Standard	Standard No.	Subclass	w.v.	Recognized No.
UL	ANSI/UL	X1	400VAC	E146544
OL	60384-14:2009	Y1	250VAC/400VAC	E140344
CSA	CAN/CSA	X1	400VAC	2347971
	E60384-14:2009	Y1	250VAC/400VAC	2517571
VDE	IEC60384-14	X1	400VAC	40001804
(ENEC)	(ed.3) 2005	Y1	250VAC/400VAC	10001001
SEV	IEC 60384-14:	X1	400VAC	11.0325
SE v	(ed3)2005	Y1	250VAC/400VAC	11.0323
SEMKO	IEC 60384-14:	X1	400VAC	1110795
SLVIKO	(ed3)2005	Y1	250VAC/400VAC	1110793
FIMKO	IEC 60384-14:	X1	400VAC	NCS/FI 24755
Pilviko	(ed3)2005	Y1	250VAC/400VAC	NCS/11 24/33
NEMKO	IEC 60384-14:	X1	400VAC	No.P11214078
NEWIKO	(ed3)2005	Y1	250VAC/400VAC	NO.F 11214078
DEMKO	IEC 60384-14:	X1	400VAC	D-00038
DEMIKO	(ed3)2005	Y1	250VAC/400VAC	D-00038
DEKRA	IEC 60384-14:	X1	400VAC	2150105.02
(KEMA)	(ed3)2005	Y1	250VAC/400VAC	2130103.02
CQC	GB/T	X1:400VAC /Y1:400VAC		CQC03001003673
- CQC	14472-1998	X1:400VAC /Y1:250VAC		CQC11001055510
KTL	K60384-14	X1	400VAC	SU03017-4004B
KIL	1500304-14	Y 1	250VAC	SU03017-4003A



7. Specification and test method:

7.1 Operating Temperature Range: -25 to +125°C

7.2 Test condition:

Test and measurement shall be made at the standard condition. (temperature $15\sim35^{\circ}$ C, relative humidity $45\sim75\%$ and atmospheric pressure $860\sim1060$ hpa). Unless otherwise specified herein.

If doubt occurred on the value of measurement, and measurement was requested by customer capacitors shall be measured at the reference condition. (temperature $20\pm2^{\circ}\text{C}$ or $25\pm2^{\circ}\text{C}$, relative humidity $60\sim70\%$ and atmospheric pressure $860\sim1060$ hpa.)

7.3 Performance:

No	It	ems	Performance	Testing method	
7.3.1		earance imension	The appearance and dimension shall be as given in section 3.	Visual check.	
7.3.2	Ma	rking	The marking shall be easily legible. (As given section 5)	Visual check.	
		Between terminals	No failure.	The capacitors shall not be damage when AC4000V (rms.) are applied between the lead wires for 60sec.	
7.3.3	Withstand voltage	Body Insulation	No failure.	First. The terminals of the capacitor shall be closely wrapped around the body of the capacitor distance of about 3 to 4mm from each terminal. Then, the capacitor shall be inserted into a container filled with metal balls of about 1mm diameter. Finally, AC4000V (rms.) is applied for 60sec between the capacitor lead wires and metal balls.	
7.3.4	Insulation Resistance	Between terminals	10000MΩ or more.	The insulation resistance shall be measured with DC500±50V within 60±5sec of charging.	
7.3.5	Capa	citance	Within specified tolerance.	B&E&F: The capacitance shall be measured at $20\pm2^{\circ}$ C with 1kHz $\pm20\%$ and 5V(rms.) or less.	
7.3.6		ipation anδ) or Q	B · E : D.F. \leq 2.5% F : D.F. \leq 5.0% CH&SL : 30pF&above: \geq 1000 Below 30PF: \geq 400+20×C	CH&SL: The capacitance shall be measured at 25°C with 1MHz±20% and 1.0±0.2Vrms	
7.3.7	-	erature cteristic	Char. Capacitance Change B Within $\pm 10\%$ E Within $\pm \frac{20}{5}\%$ F Within $-80 \sim +30\%$ CH 0 ± 60 ppm/°C $-1000 \sim +350$ SL ppm/°C $(+20$ °C $\sim +85$ °C)	The capacitance measurement shall be made at each step specified in Table 1.	
7.3.8	Solderability	of Leads	Lead wire should be soldered with uniform coating on the axial direction over 3/4 of the circumferential direction.	The lead wire of capacitor should be dipped into molten solder for 5 ± 0.5 sec. The depth of immersion is up to about 1.5 to 2.0 mm from the root of lead wires. Temp. of solder: Lead Free Solder (Sn-3Ag-0.5Cu) $245\pm5^{\circ}$ C	



No	Items		Performance	Testing method		
		Tensile	Lead wire shall not cut off. Capacitor shall not be broken.	With the termination in its normal position, the specimen is held by its body in such a manner that the axis of the termination is vertical; the tensile force of 10N shall be applied to the termination in the direction of its axis and acting in a direction away from the body of the specimen.		
7.3.9	Robustness of Terminations	Bending	Lead wire shall not cut off. Capacitor shall not be broken.	With the termination in its normal position, the specimen is held by its body in such a manner that the axis of the termination is vertical; a mass applying a force of 5N is then suspended from the end of the termination. The body of the specimen is then inclined, within a period of 2 to 3sec, through an angle of approximately 90 in the vertical plane and then returned to its initial position over the same period of time; this operation constitutes one bend. One bend immediately followed by a second bend in the opposite direction.		
		Appearance	No marked defect.	As shown in figure, the lead wires should be immersed in solder of 350 ± 10 °C or 260 ± 5 °C up to 1.5 to 2.0 mm from		
		I.R.	1000 MΩ min.	the root of terminal for 3.5 ± 0.5 sec (10 ± 1 sec. for 260 ± 5 °C).		
		Dielectric Strength	Per item7.3. 3	Thermal Capacitor		
7.3.10	Soldering Effect (Non-Preheat)	Capacitance	B,E,F: Within ±10 % SL,CH: Within±2.5% or ±0.25pF,Whichever is large.	Pre-treatment: Capacitor shall be stored at 85±2°C for 1hour.then placed at *1 room condition for 24±2hours before initial measurements. Post-treatment: Capacitor shall be stored for 1 to 2hours at *1 room condition.		
		Appearance	No marked defect.	First the capacitor should be stored at 120+0/-5 °C for 60 +0/-5 sec. Then , as in figure , the lead wires should be immersed solder of 260+0/-5 °C up to 1.5 to 2.0 mm from the root of terminal for 7.5+0/-1 sec. Thermal Capacitor Screen to 2.0 mm		
7.3.11	Soldering	I.R.	1000~MΩ min.	- T Molten		
7.3.11	Effect (On-Preheat)	Dielectric Strength	Per item 7.3.3	Solder		
		Capacitance	B,E,F: Within ±10 % SL,CH: Within±2.5% or ±0.25pF,Whichever is large.	Pre-treatment: Capacitor shall be stored at 85±2°C for 1hour.then placed at *1room condition for 24±2hours before initial measurements. Post-treatment: Capacitor shall be stored for 1 to 2hours at *1room condition.		



No	Iten	ns	Performance	Testing method
		Appearance	No marked defect.	
7.3.12	Humidity (Under steady State)	Capacitance	B: Within ±10% E: Within ±20% F: Within ±30% SL&CH: Within±2.5% or ±0.25pF,Whichever is large.	
	State)	D.F.	B,E: 5.0% max. F: 7.5% max.	condition.
		Q	SL&CH: Less than $30pF=>$ $Q \ge 100+10 \times C/3$ More than $30pF=>$ $Q \ge 200$	
7.3.13	Humidity Loading	I.R.	B,E,F: 3000MΩ min. SL&CH: 1000MΩ min.	Apply the rated voltage for 500±12 hours at 40±2°C in 90 to 95% relative humidity and set it for 1 to 2 hours at **1 room condition.
		Dielectric Strength	Per Item 7.3.3	
		Appearance	No marked defect.	Impulse Voltage
		Capacitance	B,E,F: Within ±20% SL&CH: Within±3% or ±0.3pF,Whichever is large.	Each individual capacitor shall be subjected to 8kV impulses for three times. After the capacitors are applied to life test. Fig. 2 Ver. Cx tr td.
	Life	I.R.	3000 M Ω min. SL&CH: 1000 M Ω min.	0.9Vp (uS) (uS) (uS) (uS) (0S) (0S) (0S) (0S) (0S) (0S) (0S) (0
7.3.14	Elle	Dielectric Strength	Per Item 7.3 3	The specimen capacitors are placed in a circulating air oven for a period of 1000 hours. The air in the oven is maintained at a temperature of 125±3°C. Throughout the test, the capacitors are subjected to an AC425Vrms.(for 0AH type) or AC680Vrms.(for 1AH type) alternating voltage of mains frequency, except that once each hour the voltage is increased to AC1000V(rms.) for 0.1 sec.
7.3.15	Flame	Test	The capacitor flame discontinues as follows. Cycle Time 1~4 30sec max. 5 60sec max.	The capacitor shall be subjected to applied for 15 sec and then removed for 15 sec until 5 cycles. Fig. 5 Gas Burmer (unit: mm)

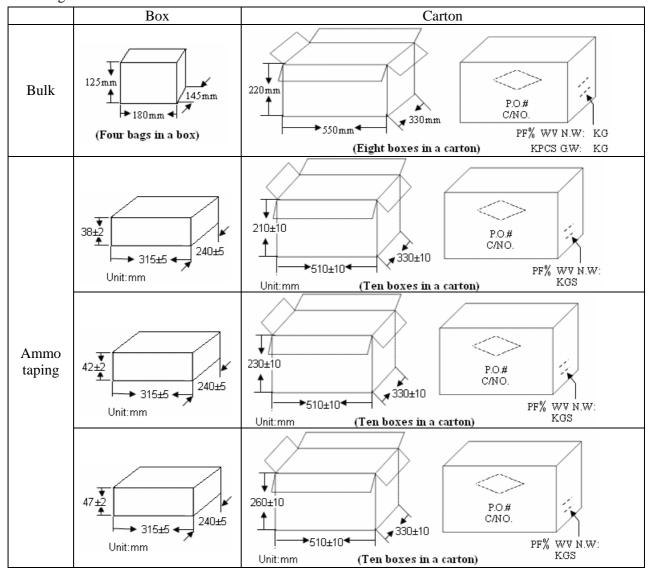


No		Items	Performance	Testing method
7.3.16		Active mmability	The cheesecloth shall not be on fire.	The specimens shall be individually wrapped in at least one but more than two complete layers of cheesecloth. The specimens shall be subjected to 20 discharges. The interval between successive discharges shall be 5 sec. The UAC shall be maintained for 2 min after the last discharge. Fig. 6 C1,2: 1µF±10% C1,2: 1µF±10% C3: 0.033µF±5% 10kV C4: 3µF±5% 10kV C5: C4 C7: C4 C7: C4 C8: C4 C9: C
7.3.17	Passive	Flammability	The burning time shall not be exceeded the time 30 sec. The tissue paper shall not ignite.	The capacitor under test shall be held in the position which best promotes burning. Each specimen shall only be exposed once to flame. Time of exposure to flame: 30sec. Length of flame: 12±1mm Gas burner: Length 35mm min. Inside Dia.: 0.5±0.1mm Outside Dia.: 0.9mm max. Gas: Butane gas Purity 95% min. Fig. 7
7.3.18	Temperat ure Cycle	Appearance Char. Cap. Change SL, $\leq \pm 5\%$ CH $= \pm 10\%$ E,F $\leq \pm 20\%$ I.R. Dielectric strength	No marked defect $ \begin{array}{ c c c } \hline DF/Q \\ \hline Q \ge 275 + 5/2C & (C \\ < 30 pF) \\ Q \ge 350 & (C \ge 30 pF) \\ \hline DF \le 5.0\% \\ \hline DF \le 7.5\% \\ \hline 3000M\Omega & min. \\ \hline Per Item 7.3.3 \\ \hline \end{array} $	The capacitor should be subjected to 5 temperature cycles, Capacitor should be subjected to 5 temperature cycles, Step Temperature(°C) Time(min)



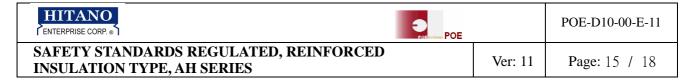
8.Packing Baggage:

8.1 Packing size:



8.2 Packing quantity:

Type of packing	One bag	One box	One carton
Bulk	500pcs	1000pcs~2000pcs	8000pcs~16000pcs
Duik	200pcs	1000pcs	8000pcs
Ammo taping (AF-Product pitch:15.0mm)		1000pcs	10000pcs
Ammo taping (AM-Product pitch:25.4mm)		500pcs	5000pcs



9. Notices:

9.1 Caution (Rating):

(1). Operating Voltage

Be sure to maintain the Vp-p value of the applied voltage or the Vo-p which contains DC bias within the rated voltage range.

When the voltage is started to apply to the circuit or it is stopped applying, the irregular voltage may be generated for a transit period because of resonance or switching. Be sure to use a capacitor within rated voltage containing this irregular voltage.

Voltage	DC Voltage	DC+AC Voltage	AC Voltage	Pulse Voltage (1)	Pulse Voltage (2)
Positional Measurement	V0-p	Vo-p	Vp-p	Vp-p	Vp-p

(2). Operating Temperature and Self-generated Heat

Keep the surface temperature of a capacitor below the upper limit of its rated operating temperature range. Be sure to take into account the heat generated by the capacitor itself. When the capacitor is used in a high-frequency current, pulse current or the like, it may have the self-generated heat due to dielectric-loss.

Applied voltage should be the load such as self-generated heat is within 20°C on the condition of atmosphere temperature 25°C . When measuring, use a thermocouple of small thermal capacity-K of $\phi 0.1 \text{mm}$ and be in the condition where capacitor is not affected by radiant heat of other components and wind of surroundings. Excessive heat my lead to deterioration of the capacitor's characteristics and reliability.

(3). Test condition for withstanding Voltage

I. Test Equipment

Test equipment for AC withstanding voltage shall be used with the performance of the wave similar to 50/60 Hz sine waves.

If the distorted sine wave or over load exceeding the specified voltage value is applied, the defective may be caused.



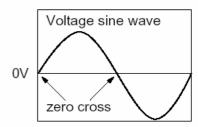
II. Voltage Applied Method

When the withstanding voltage is applied, capacitor's lead or terminal shall be firmly connected to the output of the withstanding voltage test equipment, and then the voltage shall be raised from near zero to the test voltage.

If the test voltage without the raise from near zero voltage would be applied directly to capacitor, test voltage should be applied with the *zero cross. At the end of the test time, the test voltage shall be reduced to near zero, and then capacitor's lead or terminal shall be taken off the output of the withstanding voltage test equipment.

If the test voltage without the raise from near zero voltage would be applied directly to capacitor, the surge voltage may arise, and therefore, the defective may be caused.

ZERO CROSS is the point where voltage sine wave pass 0V.- See the right figure.



(4). Fail-Safe

When capacitor would be broken, failure may result in a short circuit. Be sure to provide an appropriate fail-safe function like a fuse on your product if failure would follow an electric shock, fire or fume.

Failure to follow the above cautions may result, worst case, in a short circuit and cause fuming or partial dispersion when the product is used.

9.2 Caution (Storage and operating condition):

Operating and storage environment

The insulating coating of capacitors does not form a perfect seal; therefore, do not use or store capacitors in a corrosive atmosphere, especially where chloride gas, sulfide gas, acid, alkali, salt or the like are present. And avoid exposure to moisture. Before cleaning, bonding, or molding this product, verify that these processes do not affect product quality by testing the performance of a cleaned, bonded or molded product in the intended equipment. Store the capacitors where the temperature and relative humidity do not exceed –10 to 40 degrees centigrade and 15 to 85 %. Use capacitors within 6 months.

"Failure to follow the above cautions may result, worst case, in a short circuit and cause fuming or partial dispersion when the product is used."

9.3 Caution (Soldering and Mounting):

9.3.1 Vibration and impact:

Do not expose a capacitor or its leads to excessive shock or vibration during use.



9.3.2 Soldering:

When soldering this product to a PCB/PWB, do not exceed the solder heat resistance specification of the capacitor. Subjecting this product to excessive heating could melt the internal junction solder and may result in thermal shocks that can crack the ceramic element.

When soldering capacitor with a soldering iron, it should be performed in following conditions.

Temperature of iron-tip: 400 degrees C. max.

Soldering iron wattage: 50W max.

Soldering time: 3.5 sec. max.

9.3.3 Cleaning (ultrasonic cleaning):

To perform ultrasonic cleaning, observe the following conditions.

Rinse bath capacity: Output of 20 watts per liter or less.

Rinsing time:5 min maximum.

Do not vibrate the PCB/PWB directly.

Excessive ultrasonic cleaning may lead to fatigue destruction of the lead wires.

"Failure to follow the above cautions may result, worst case, in a short circuit and cause fuming or partial dispersion when the product is used."

9.4 Caution (Handling):

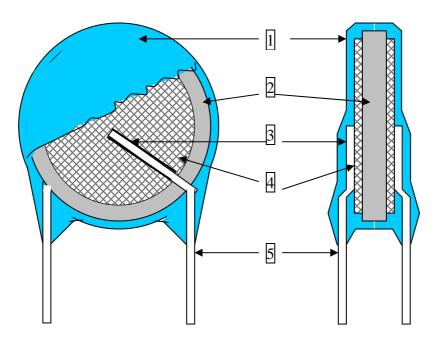
Vibration and impact

Do not expose a capacitor or its leads to excessive shock or vibration during use.

"Failure to follow the above cautions may result, worst case, in a short circuit and cause fuming or partial dispersion when the product is used."

HITANO ENTERPRISE CORP. (a)	POLIFICATIONIC POE		POE-D10-00-E-11
SAFETY STANDARDS REGULATED, REINFORCED INSULATION TYPE, AH SERIES		Ver: 11	Page: 18 / 18

10. Drawing of internal structure and material list:



Remarks:

No.	Part name	Material	Model/Type	Component
1	Insulation Coating	Epoxy polymer	1.EF-150C 2.EF-150(HF) 3.PCE-210 2.PCE-300(HF)	Epoxy resin、Pigment (Blue / UL 94 V-0 /) The minimum thickness of coating (reinforced insulation) is 0.4mm
2	Dielectric Element	Ceramic	CH/SL/Y5P/Y5U/Y5V	$BaTiO_3$
3	Solder	Tin-silver	Sn96.5-Ag3-Cu0.5	Sn96.5-Ag3-Cu0.5
4	Electrodes	Ag	1.SP-160PL 2.SP-260PL	Silver · Glass frit
5	Leads wire	Tinned copper clad steel wire	0.6+0.1/-0.05mm	Substrate metal: Fe & Cu Surface plating: Sn 100%(3~7μm)